



Features

- Lead free
- RoHS compliant*
- Low profile package
- Surface mount
- Very low forward voltage drop



This series is currently available but not recommended for new designs.

CD1607-B140 / B140L Schottky Barrier Rectifier Chip Diode

General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers Schottky Rectifier Diodes for rectification applications, in compact chip package 1607 (Mini-SMA) size format, which offer PCB real estate savings and are considerably smaller than competitive parts. The Schottky Rectifier Diodes offer a forward current of 1 A with a repetitive peak reverse voltage of 40 V.

Bourns® Chip Diodes conform to JEDEC standards, easy to handle on standard pick and place equipment and their flat configuration makes roll away much more difficult.

Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	CD1607-		Unit
		B140	B140L	
Forward Voltage (Max.) ($I_F = 1\text{ A}$)	V_F	0.5	0.4	V
Typical Junction Capacitance*	C_T	110	110	pF
Reverse Current (Max.) at Rated V_R	I_R	0.5	1.0	mA

* Measured at 1.0 MHz and applied reverse voltage of 4.0 V DC.

Absolute Ratings (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	CD1607-		Unit
		B140	B140L	
Repetitive Peak Reverse Voltage	V_{RRM}	40	40	V
Reverse Voltage	V_R	40	40	V
Maximum RMS Voltage	V_{RMS}	28	28	V
Avg. Forward Current	I_O	1		A
Forward Current, Surge Peak (60 Hz, 1 cycle)	I_{surge}	30*		A
Typical Thermal Resistance**	$R_{\theta JL}$	20		$^\circ\text{C/W}$
Storage Temperature	T_{STG}	-55 to +150		$^\circ\text{C}$
Junction Temperature	T_J	-55 to +125		$^\circ\text{C}$

** Thermal resistance junction to lead.

* Condition: 8.3 ms single half sine-wave superimposed on rate load (JEDEC method).

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*RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and

RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.

How To Order

CD 1607 - B 1 40 L LF

Common Code _____
Chip Diode _____

Package _____
• 1607 = Mini-SMA

Model _____
B = Schottky Barrier Series

Average Forward Current (I_O) Code _____
1 = 1 A (Code x 1000 mA = Average Forward Current)

Reverse Voltage (V_R) Code _____
40 = 40 V

Forward Voltage Suffix _____
L = Low Forward Voltage V_F

Terminations _____
LF = 100 % Sn (lead free)

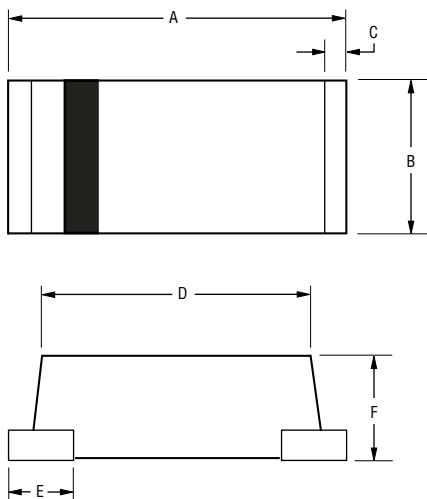
Applications

- Cellular phones
- PDAs
- Desktop PCs and notebooks
- Digital cameras
- MP3 players

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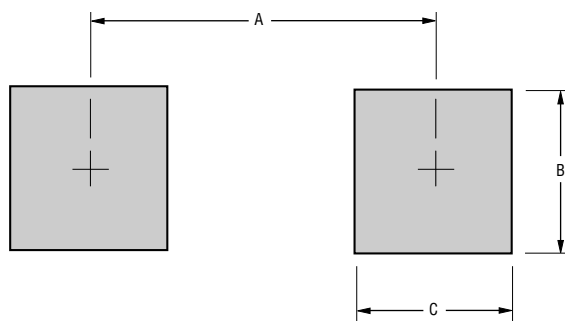
Product Dimensions



Dimension	Mini-SMA
A	$\frac{3.70 - 4.10}{(0.146 - 0.161)}$
B	$\frac{1.40 - 1.80}{(0.055 - 0.071)}$
C	$\frac{0.30}{(0.012)}$ TYP.
D	$\frac{2.40 - 2.80}{(0.094 - 0.110)}$
E	2 PLCS. $\frac{0.90}{(0.035)}$ TYP.
F	$\frac{1.40 - 1.60}{(0.055 - 0.063)}$

DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

Recommended Pad Layout



Dimension	Mini-SMA
A (Max.)	$\frac{3.50}{(0.138)}$
B (Min.)	$\frac{1.50}{(0.059)}$
C (Min.)	$\frac{1.50}{(0.059)}$

DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

Physical Specifications

Case.....1607 Molded plastic
PolarityColor band denotes cathode end
Terminals.....Solderable per MIL-STD-750, Method 206
WeightApproximately 0.04 grams

Typical Part Marking

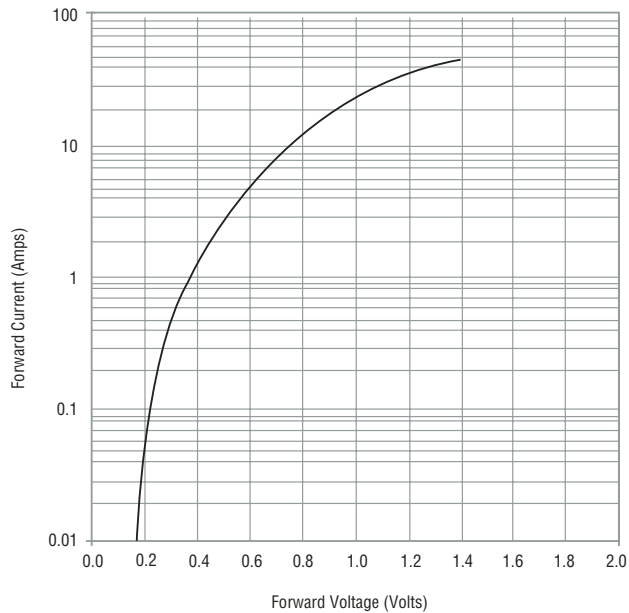
CD1607-B140I4
CD1607-B140LI4

CD1607-B140 / B140L Schottky Barrier Rectifier Chip Diode

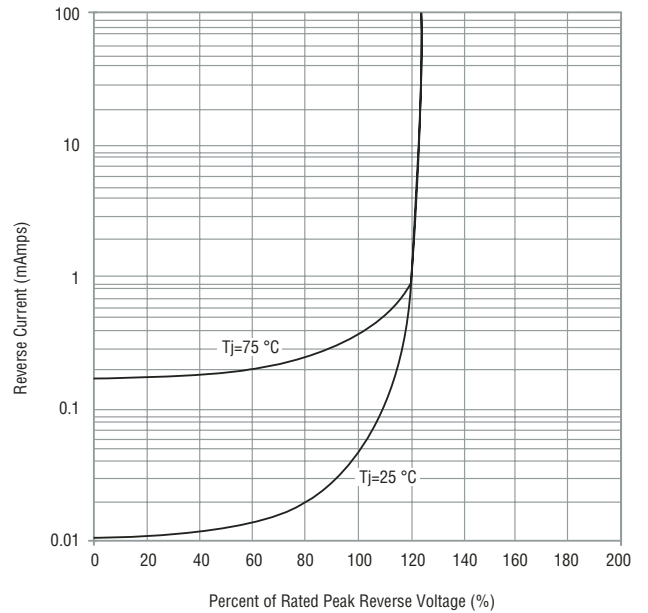
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Rating and Characteristic Curves: CD1607-B140

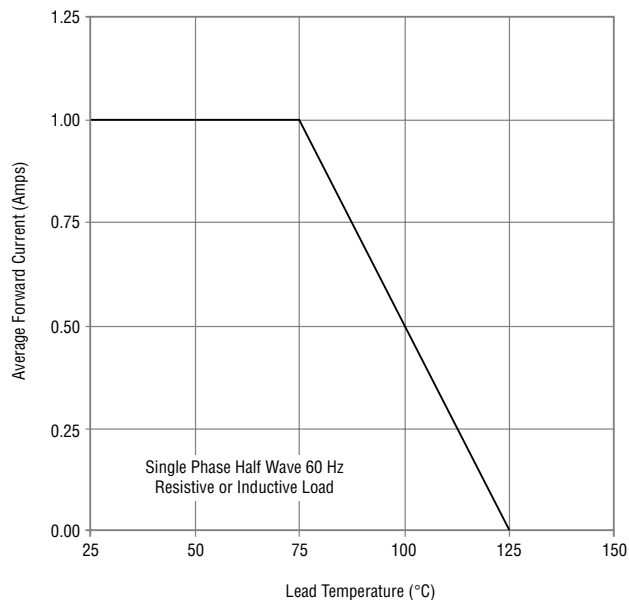
Forward Characteristics



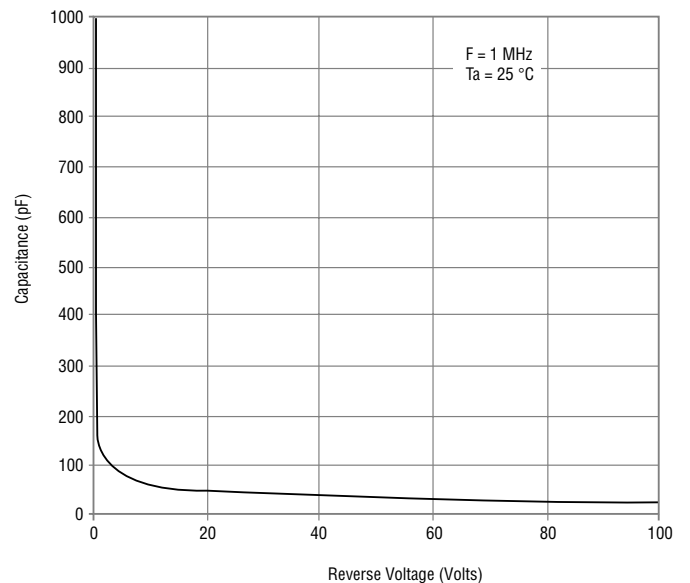
Reverse Characteristics



Derating Curve



Capacitance Between Terminals



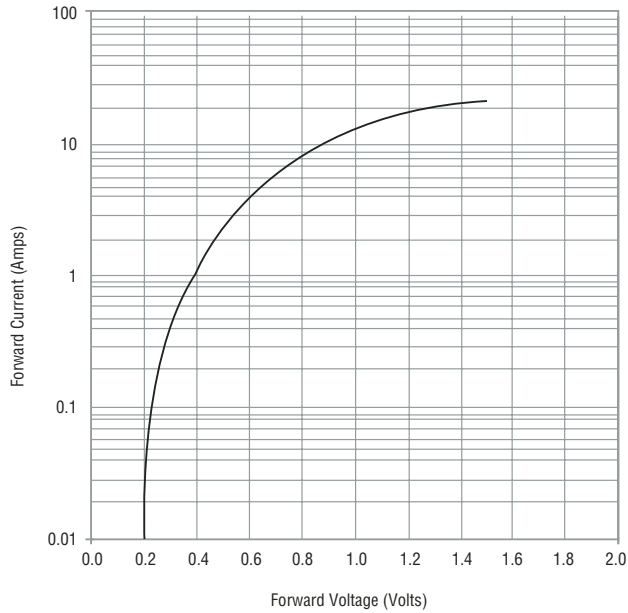
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CD1607-B140 / B140L Schottky Barrier Rectifier Chip Diode

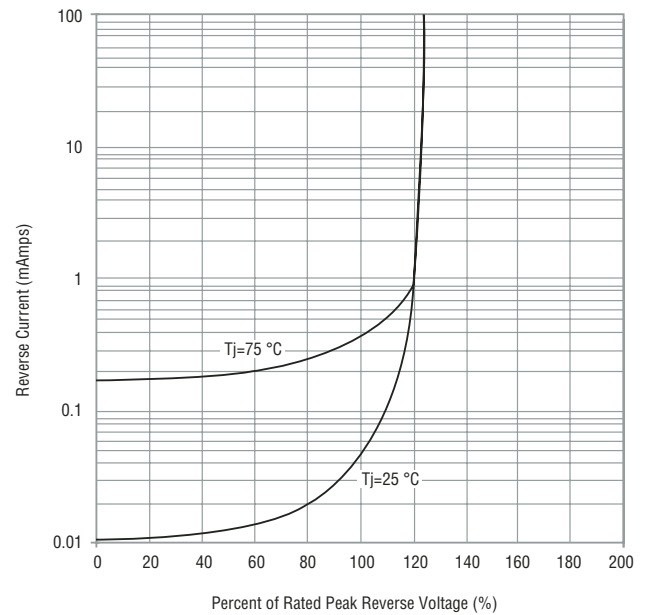
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Rating and Characteristic Curves: CD1607-B140L

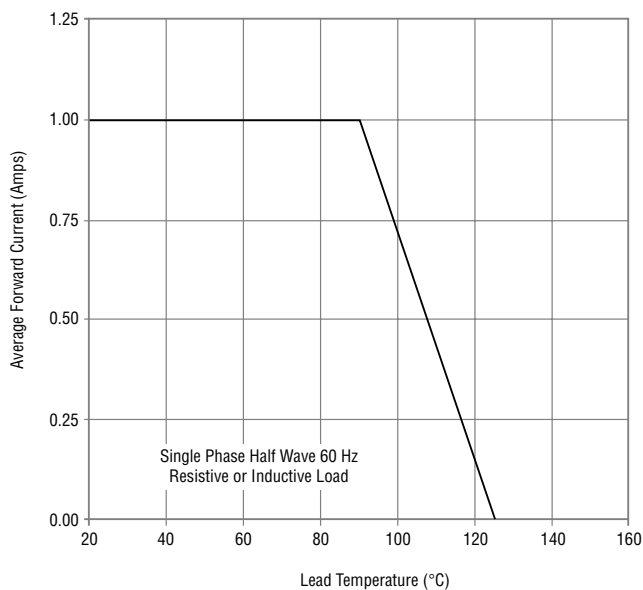
Forward Characteristics



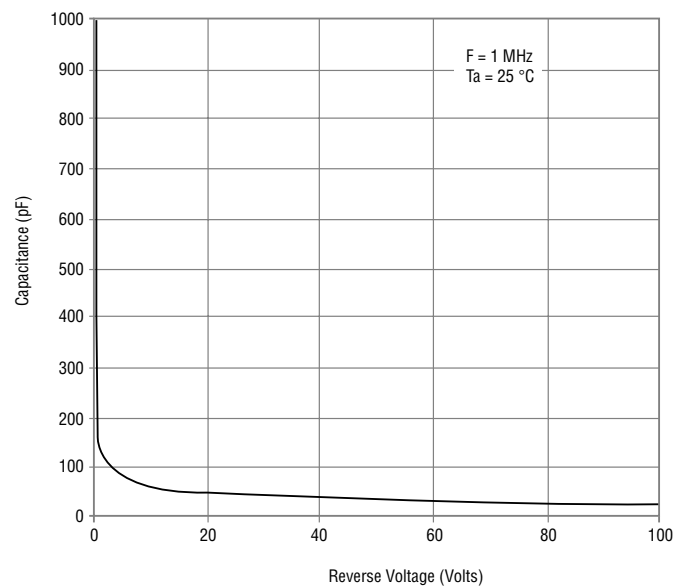
Reverse Characteristics



Derating Curve



Capacitance Between Terminals



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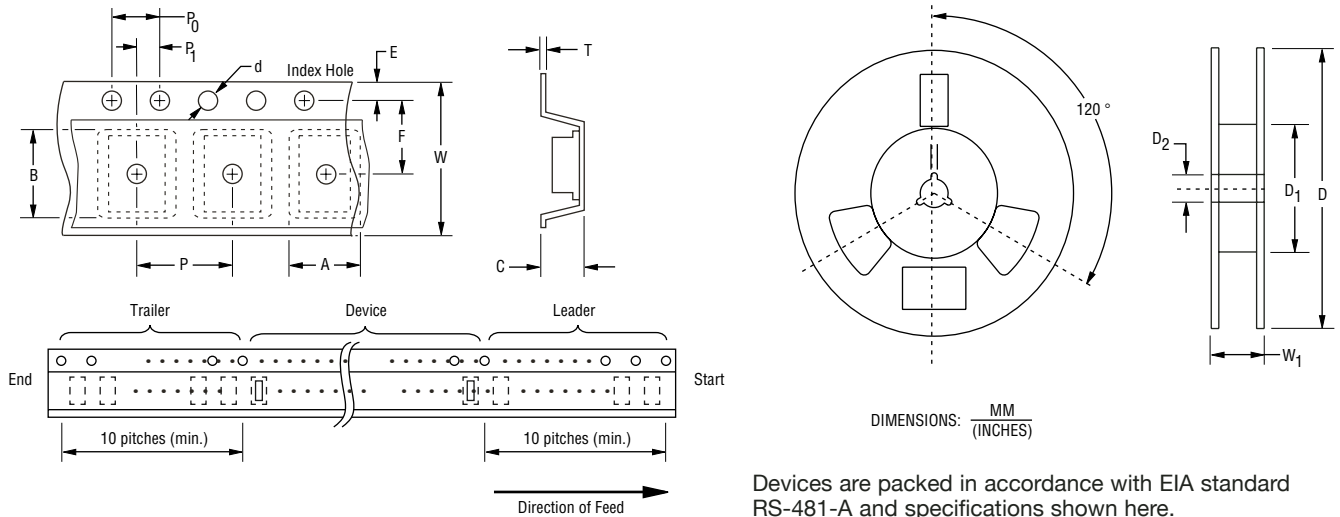
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Packaging Information

The product will be dispensed in Tape and Reel format (see diagram below).



Item	Symbol	1607
Carrier Width	A	$\frac{1.90 \pm 0.10}{(0.075 - 0.004)}$
Carrier Length	B	$\frac{4.30 \pm 0.10}{(0.169 - 0.004)}$
Carrier Depth	C	$\frac{1.80 \pm 0.10}{(0.071 - 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 - 0.002)}$
Reel Outside Diameter	D	$\frac{178}{(7.008)}$
Reel Inner Diameter	D ₁	$\frac{80.0}{(3.150)} \text{ MIN.}$
Feed Hole Diameter	D ₂	$\frac{13.0 \pm 0.20}{(0.512 - 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 - 0.004)}$
Punch Hole Position	F	$\frac{3.50 \pm 0.05}{(0.138 - 0.002)}$
Punch Hole Pitch	P	$\frac{4.00 \pm 0.10}{(0.157 - 0.004)}$
Sprocket Hole Pitch	P ₀	$\frac{4.00 \pm 0.10}{(0.157 - 0.004)}$
Embossment Center	P ₁	$\frac{2.00 \pm 0.05}{(0.079 - 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.10}{(0.008 - 0.004)}$
Tape Width	W	$\frac{8.00 \pm 0.20}{(0.315 - 0.008)}$
Reel Width	W ₁	$\frac{13.5}{(0.531)} \text{ MAX.}$
Quantity per Reel	--	2,500

REV. 12/15

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